



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: Cummings et al.

Attorney Docket No.: FULCP009

Application No.: 10/634,597

Examiner: Not yet assigned

Filing Date: August 4, 2003

Group: 2631

Title: ASYNCHRONOUS SYSTEM-ON-A-CHIP  
INTERCONNECT

Confirmation No.: 6534

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as first-class mail on June 9, 2004 in an envelope addressed to the Commissioner for Patents, P.O. Box 1450 Alexandria, VA 22313-1450.

Signed: \_\_\_\_\_

Mia Mitchell-Haynes

**SUBMISSION OF SUPPLEMENTAL APPLICATION DATA SHEET**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

Enclosed is a Supplemental Application Data Sheet for the above-identified application. This Supplemental Application Data Sheet is being submitted to provide the domestic priority information which satisfies the specific reference requirement under 35 U.S.C. 119(e) and 35 U.S.C. 120.

Respectfully submitted,  
BEYER WEAVER & THOMAS, LLP

Joseph M. Villeneuve  
Reg. No. 37,460

P.O. Box 778  
Berkeley, CA 94704-0778



## **APPLICATION DATA SHEET**

### **Application Information**

<b>Application number::</b>	<b>10/634,597</b>
<b>Filing Date::</b>	<b>08/04/03</b>
<b>Application Type::</b>	<b>Utility</b>
<b>Subject Matter::</b>	<b>Regular</b>
<b>CD-ROM or CD-R::</b>	<b>No</b>
<b>Title::</b>	<b>ASYNCHRONOUS SYSTEM-ON-A-CHIP INTERCONNECT</b>
<b>Attorney Docket Number::</b>	<b>FULCP009</b>
<b>Request for Early Publication::</b>	<b>No</b>
<b>Request for Non-Publication::</b>	<b>No</b>
<b>Total Drawing Sheets::</b>	<b>75</b>
<b>Small Entity::</b>	<b>No</b>
<b>Petition Included::</b>	<b>No</b>
<b>Secrecy Order in Parent Appl.?::</b>	<b>No</b>

### **Applicant Information**

<b>Applicant Authority Type::</b>	<b>Inventor</b>
<b>Primary Citizenship Country::</b>	<b>U.S.</b>
<b>Status::</b>	<b>Full Capacity</b>
<b>Given Name::</b>	<b>Uri</b>
<b>Middle Name::</b>	
<b>Family Name::</b>	<b>Cummings</b>
<b>Name Suffix::</b>	
<b>City of Residence::</b>	<b>Oak Park</b>
<b>State or Province of Residence::</b>	<b>CA</b>
<b>Country of Residence::</b>	<b>USA</b>

**Street of Mailing Address::** 5792 Oak Bend Lane, Unit 103  
**City of Mailing Address::** Oak Park  
**State or Province of Mailing Address::** CA  
**Country of Mailing Address::** USA  
**Postal or Zip Code of Mailing Address::** 91377

**Applicant Authority Type::** Inventor  
**Primary Citizenship Country::** U.S.  
**Status::** Full Capacity  
**Given Name::** Andrew

**Middle Name::**  
**Family Name::** Lines  
**Name Suffix::**  
**City of Residence::** Calabasas

**State or Province of Residence::** CA  
**Country of Residence::** USA  
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**Country of Mailing Address::** USA  
**Postal or Zip Code of Mailing Address::** 91302

## Correspondence Information

Correspondence Customer Number:: 22434

## Representative Information

Representative Customer Number:	22434
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## Domestic Priority Information

<u>Application::</u>	<u>Continuity Type:</u>	<u>Parent Application::</u>	<u>Parent Filing Date::</u>
This application	Continuation-in-part under 35 U.S.C. 120	10/136,025	04/30/02
This application	Continuation-in-part under 35 U.S.C. 120	10/212,574	08/01/02
This application	Claims benefit under 35 USC 119(e)	60/444,820	02/03/03

## Assignee Information

Assignee Name:: Fulcrum Microsystems, Inc.  
Street of Mailing Address:: 26775 Malibu Hills Road, Suite 200  
City of Mailing Address:: Calabasas Hills  
State or Province of Mailing Address:: CA  
Country of Mailing Address:: USA  
Postal or Zip Code of Mailing Address:: 91301